# PME271Y Series Metallized Impregnated Paper, Class Y2, 250 VAC



#### **Overview**

The PME271Y Series is constructed of multilayer metallized paper encapsulated and impregnated in self-extinguishing material meeting the requirements of UL 94 V–0.

### **Applications**

Typical applications include worldwide use as electromagnetic interference suppressor in all Y2 applications, line-to-earth.

#### **Benefits**

Approvals: ENEC, UL, cUL, CQC
 Rated voltage: 250 VAC 50/60 Hz
 Capacitance range: 0.001 – 0.1 μF

• Lead spacing: 10.2 – 25.4 mm

• Capacitance tolerance: ±20%

Climatic category: 40/100/56/B, IEC 60068–1

Tape and reel packaging in accordance with IEC 60286–2

· RoHS Compliant and lead-free terminations

Operating temperature range of -40°C to +100°C

100% screening factory test at 3,000 VDC

Highest possible safety regarding active and passive flammability



## **Legacy Part Number System**

PME271	Υ	410	M	R30
Series	Rated Voltage (VAC)	Capacitance Code (pF)	Capacitance Tolerance	Packaging
Y2, Metallized Paper	Y = 250	The last two digits represent significant figures. The first digit specifies the total number of digits.	M = ±20%	See Ordering Options Table

## **New KEMET Part Number System**

Р	271	Н	Е	102	M	250	Α
Capacitor Class	Series	Lead Spacing (mm)	Size Code	Capacitance Code (pF)	Capacitance Tolerance	Rated Voltage (VAC)	Lead and Packaging Code
P = Paper	Y2, Metallized Paper	H = 10.2 Q = 15.2 C = 20.3 E = 25.4	See Dimension Table	First two digits represent significant figures. Third digit specifies number of zeros.	M = ±20%	250 = 250	See Ordering Options Table



#### Benefits cont'd

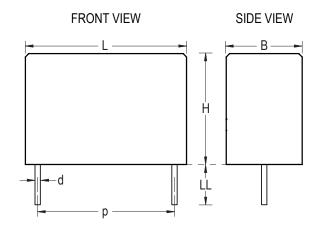
- Excellent self-healing properties ensure long life even when subjected to frequent over-voltages
- Good resistance to ionization due to impregnated dielectric
- High dV/dt capability
- Impregnated paper ensures excellent stability and reliability properties, particularly in applications with continuous operation

## **Ordering Options Table**

Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	KEMET Lead and Packaging Code	Legacy Lead and Packaging Code
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06
10.2	Bulk (Bag) – Max Length Leads	30 +5/-0	А	R30
10.2	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 +/−0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 +/-0.5	Р	R19T1
Native 10.2 formed to 7.5	Ammo Pack	H <sub>0</sub> = 16.5 +/-0.5	LAF3	R30XA
	Standard Lead and Packaging Options			
	Bulk (Bag) – Short Leads	6 +0/-1	С	R06
15.2	Bulk (Bag) – Max Length Leads	30 +5/-0	А	R30
15.2	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 +/-0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 +/−0.5	Р	R19T1
	Standard Lead and Packaging Options			
	Bulk (Tray) – Short Leads	6 +0/-1	С	R06
20.3	Bulk (Bag) – Max Length Leads	30 +5/-0	А	R30
20.3	Tape & Reel (Standard Reel)	H <sub>0</sub> = 18.5 +/-0.5	L	R19T0
	Other Lead and Packaging Options			
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 +/−0.5	Р	R19T1
	Standard Lead and Packaging Options			
25.4	Bulk (Tray) – Short Leads	6 +0/-1	С	R06
	Bulk (Bag) – Max Length Leads	30 +5/-0	А	R30



## **Dimensions – Millimeters**



	р	В			H L		L		d
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
10.2	+/-0.4	3.9	Maximum	7.5	Maximum	13.5	Maximum	0.6	+/-0.05
10.2	+/-0.4	4.1	Maximum	8.2	Maximum	13.5	Maximum	0.6	+/-0.05
10.2	+/-0.4	5.1	Maximum	10.5	Maximum	13.5	Maximum	0.6	+/-0.05
15.2	+/-0.4	5.2	Maximum	10.5	Maximum	18.5	Maximum	0.8	+/-0.05
15.2	+/-0.4	5.5	Maximum	11	Maximum	18.5	Maximum	0.8	+/-0.05
15.2	+/-0.4	7.3	Maximum	13	Maximum	18.5	Maximum	0.8	+/-0.05
20.3	+/-0.4	7.6	Maximum	14	Maximum	24	Maximum	0.8	+/-0.05
20.3	+/-0.4	9	Maximum	15	Maximum	24	Maximum	0.8	+/-0.05
20.3	+/-0.4	11.3	Maximum	16.5	Maximum	24	Maximum	0.8	+/-0.05
25.4	+/-0.4	12.1	Maximum	19	Maximum	30.5	Maximum	1	+/-0.05
	•		Note: See Ord	ering Options Ta	ble for lead lengt	h (LL) options.	•		



### **Performance Characteristics**

Rated Voltage	250 VAC 50/60 Hz				
Capacitance Range	0.001 – 0.1 μF				
Capacitance Tolerance	±20%				
Temperature Range	-40°C to +100°C				
Climatic Category	40/100/56/B				
Approvals	ENEC, UL, CSA, CQC				
Discipation Factor	Maximum Values at +23°C				
Dissipation Factor	1 kHz	1.3%			
Test Voltage Between Terminals	The 100% screening factory test is carried out at 3,000 VDC. The voltage level is selected to meet the requirements in applicable equipment standards. All electrical characteristics are checked after the test. It is not permitted to repeat this test as there is a risk to damage the capacitor. KEMET is not liable in such case for any failures.				
Insulation Resistance	Minimum Value Between Terminals				
insulation Resistance	≥ 12,000 MΩ				
In DC Applications	Recommended voltage ≤ 1,000 VD	С			

## **Environmental Test Data**

Test	IEC Publication	Procedure
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 500 Hz at 0.75 mm or 98 m/s <sup>2</sup>
Bump	IEC 60068-2-29 Test Eb	4,000 bumps at 390 m/s <sup>2</sup>
Solderability	IEC 60068-2-20 Test Ta	Solder globule method
Active Flammability	IEC 60384-14	
Passive Flammability	IEC 60384-14	Needle-flame test
Humidity	IEC 60068-2-3 Test Ca	+40°C and 90 – 95% RH



## **Approvals**

Mark	Specification	File Number
	EN/IEC 60384-14	SE/0140-27D
c <b>Fl</b> us	UL 60384-14 CAN/CSA-E60384-14-09	E73869
Cac	CQC	10001043355

## **Environmental Compliance**

All KEMET EMI capacitors are RoHS Compliant.

**Table 1 – Ratings & Part Number Reference** 

Capacitance Maximum Dimensions in		ns in mm	Lead	f	dV/dt	New KEMET	Legacy Part	
Value (µF)	В	Н	L	Spacing (p)	(MHz)	(V/µs)	Part Number	Number
0.0010	3.9	7.5	13.5	10.2	53	2000	P271HE102M250(1)	PME271Y410M(1)
0.0015	3.9	7.5	13.5	10.2	44	2000	P271HE152M250(1)	PME271Y415M(1)
0.0022	3.9	7.5	13.5	10.2	37	2000	P271HE222M250(1)	PME271Y422M(1)
0.0033	4.1	8.2	13.5	10.2	30	2000	P271HH332M250(1)	PME271Y433M(1)
0.0047	5.1	10.5	13.5	10.2	24	2000	P271HL472M250(1)	PME271Y447M(1)
0.0068	5.2	10.5	18.5	15.2	19	1400	P271QE682M250(1)	PME271Y468M(1)
0.0100	5.2	10.5	18.5	15.2	16	1400	P271QE103M250(1)	PME271Y510M(1)
0.0150	5.5	11.0	18.5	15.2	13	1400	P271QH153M250(1)	PME271Y515M(1)
0.0220	7.3	13.0	18.5	15.2	9.8	1400	P271QM223M250(1)	PME271Y522M(1)
0.0330	7.6	14.0	24.0	20.3	7.0	1000	P271CE333M250(1)	PME271Y533M(1)
0.0470	9.0	15.0	24.0	20.3	6.0	1000	P271CJ473M250(1)	PME271Y547M(1)
0.0680	11.3	16.5	24.0	20.3	4.6	600	P271CP683M250(1)	PME271Y568M(1)
0.1000	12.1	19.0	30.5	25.4	3.9	400	P271EJ104M250(1)	PME271Y610M(1)
Capacitance Value (µF)	B (mm)	H (mm)	L (mm)	Lead Spacing (p)	f <sub>o</sub> (MHz)	dV/dt (V/µs)	New KEMET Part Number	Legacy Part Number

(1) Insert ordering code for lead type and packaging. See Ordering Options Table for available options.



## **Soldering Process**

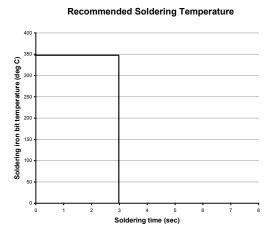
The implementation of the RoHS directive has resulted in the selection of SnAgCu (SAC) alloys or SnCu alloys as primary solder. This has increased the liquidus temperature from that of 183°C for SnPb eutectic alloy to 217 – 221°C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher pre-heat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is 160 – 170°C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 mm to 15 mm), and great care has to be taken during soldering. The recommended solder profiles from KEMET should be used. Please consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid guideline for successful soldering. Please see Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above the recommended limits may result to degradation or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after the curing of surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Please allow time for the capacitor surface temperature to return to a normal temperature before the second soldering cycle.

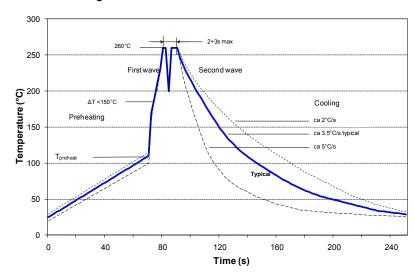
#### Manual Soldering Recommendations

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum) with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





## **Soldering Process cont'd**

#### Wave Soldering Recommendations cont'd

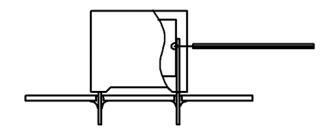
1. The table indicates the maximum set-up temperature of the soldering process Figure 1

Dielectric		imum Pre emperatu	Maximum Peak Soldering Temperature		
Film Material	Pitch Pitch Pitch		Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm
Polyester	130°C	130°C	130°C	270°C	270°C
Polypropylene	100°C	110°C	130°C	260°C	270°C
Paper	130°C	130°C	140°C	270°C	270°C
Polyphenylene Sulphide	150°C	150°C	160°C	270°C	270°C

2. The maximum temperature measured inside the capacitor:

Set the temperature so that inside the element the maximum temperature is below the limit:

Dielectric Film Material	Maximum temperature measured inside the element			
Polyester	160°C			
Polypropylene	110°C			
Paper	160°C			
Polyphenylene sulphide	160°C			



Temperature monitored inside the capacitor.

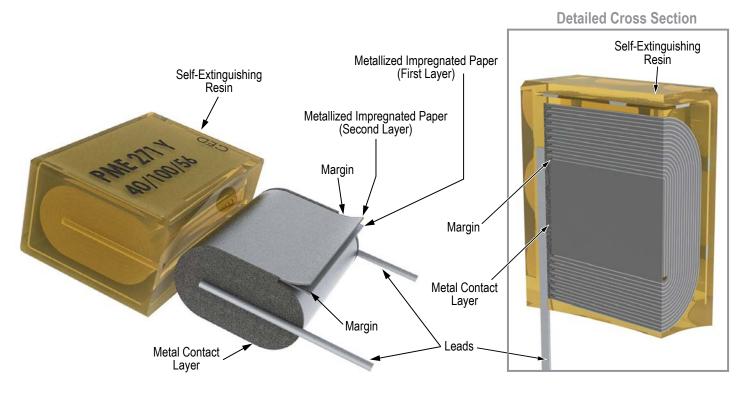
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as in normal flow soldering without touching the solder. When the board is over the bath, it is stopped and pre-designed solder pots are lifted from the bath with molten solder only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

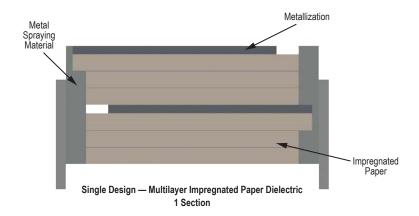
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document, **however**, **instead of two baths**, **there is only one bath with a time from 3 to 10 seconds**. In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts are not overheated.



#### Construction

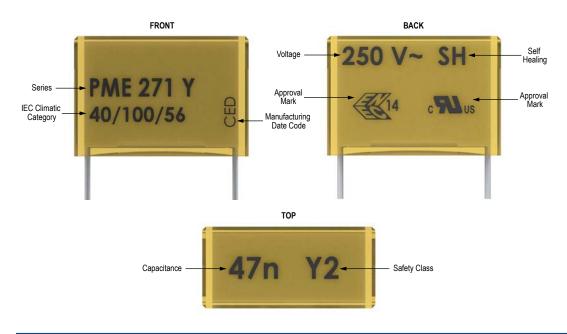


### **Winding Scheme**





## Marking



## **Packaging Quantities**

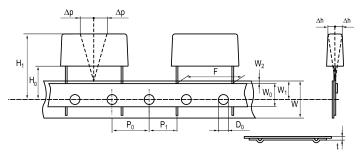
Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads	Bulk Long Leads	Standard Reel ø 360 mm	Large Reel ø 500 mm	Ammo Formed
	3.9	7.5	13.5	2000	1000	700	1400	800
10.2	4.1	8.2	13.5	2000	1000	600		780
	5.1	10.5	13.5	1600	800	600	1200	630
	5.5	12.5	18	1000	500	600		
	6.5	12.5	18	600	400	400		
	7.5	14.5	18	600	400	400		
	8.5	16	18	400	250	400		
45.0	5.2	10.5	18.5	1000	500	600		
15.2	5.5	11	18.5	1000	500	500		
	6	12.5	18.5	600	400	400		
	7.3	13	18.5	600	400	400	800	
	7.8	13.5	18.5	600	400	400		
	8.5	14.3	18.5	500	300	350		
	7.6	14	24	1500	250	250	500	
20.3	8.4	14	24	1200	200	250	500	
20.5	9	15	24	1500	200	250		
	11.3	16.5	24	1000	150	180	400	
	10.0	10.4	00.5	4000	450			
	10.6	16.1	30.5	1000	150			
25.4	10.5	17.3	30.5	1000	100			
20.7	12.1	19	30.5	800	100			
	15.3	22	30.5	600	75			



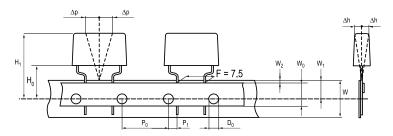
## Lead Taping & Packaging (IEC 60286-2)

### Lead Spacing 10.2 - 15.2 mm

#### Lead Spacing 20.3 - 22.5 mm



#### Formed Leads from 10.2 to 7.5 mm



## **Taping Specification**

	Standard IEC 60286-2							
Lead spacing	+6/-0.1	F	Formed 7.5	10.2	15.2	20.3	22.5	F
Carrier tape width	+/-0.5	W	18	18	18	18	18	18+1/-0.5
Hold-down tape width	+/-0.3	$W_{0}$	9	12	12	12	12	
Position of sprocket hole	+/-0.5	W <sub>1</sub>	9	9	9	9	9	g+0.75/-0.5
Distance between tapes	Maximum	$W_2$	3	3	3	3	3	3
Sprocket hole diameter	+/-0.2	D <sub>0</sub>	4	4	4	4	4	4
Feed hole lead spacing	+/-0.3	P <sub>0</sub> <sup>(1)</sup>	12.7(4)	12.7	12.7	12.7	12.7	12.7
Distance lead – feed hole	+/-0.7	P <sub>1</sub>	3.75	7.6	5.1	8.9	5.3	P¹
Deviation tape – plane	Maximum	Δр	1.3	1.3	1.3	1.3	1.3	1.3
Lateral deviation	Maximum	Δh	2	2	2	2	2	2
Total thickness	+/-0.2	t	0.7	0.7	0.7	0.7	0.9 <sup>MAX</sup>	0.9 <sup>MAX</sup>
Sprocket hole/cap body	Nominal	H <sub>0</sub> <sup>(2)</sup>	18+2/-0	18+2/-0	18+2/-0	18+2/-0	18.5+/-0.5	18+2/-0
Sprocket hole/top of cap body	Maximum	H <sub>1</sub> <sup>(3)</sup>	35	35	35	35	58	58 <sup>MAX</sup>

<sup>(1)</sup> Maximum cumulative feed hole error, 1 mm per 20 parts.

<sup>(2) 16.5</sup> mm available on request.

<sup>(3)</sup> Depending on case size.

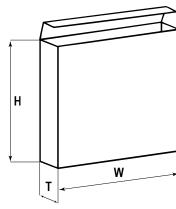
<sup>(4) 15</sup> mm available on request.



## Lead Taping & Packaging (IEC 60286-2) cont'd

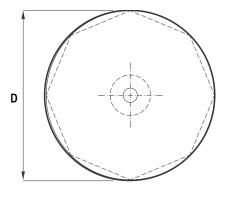
## **Ammo Specifications**

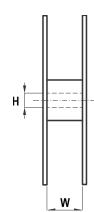
Series	Dimensions (mm)		
	Н	W	Т
R4x, R4x+R, R7x, RSB			
F5A, F5B, F5D	360	340	59
F6xx, F8xx			
PHExxx, PMExxx, PMRxxx	330	330	50



## **Reel Specifications**

Carias	Dimensions (mm)		
Series	D	Н	W
R4x, R4x+R, R7x, RSB	055	00	
F5A, F5B, F5D	355 500	30 25	55 (Max)
F6xx, F8xx	300	25	
PHExxx, PMExxx, PMRxxx	360 500	30	46 (Max)





## **Manufacturing Date Code (IEC-60062)**

Y = Year, Z = Month					
Year	Code	Month	Code		
2000	M	January	1		
2001	N	February	2		
2002	Р	March	3		
2003	R	April	4		
2004	S	May	5		
2005	T	June	6		
2006	U	July	7		
2007	V	August	8		
2008	W	September	9		
2009	X	October	0		
2010	Α	November	N		
2011	В	December	D		
2012	С				
2013	D				
2014	E				
2015	F				
2016	Н				
2017	J				
2018	K				
2019	L				
2020	M				



## **KEMET Corporation World Headquarters**

2835 KEMET Way Simpsonville, SC 29681

Mailing Address: P.O. Box 5928 Greenville, SC 29606

www.kemet.com Tel: 864-963-6300 Fax: 864-963-6521

Corporate Offices Fort Lauderdale, FL Tel: 954-766-2800

#### **North America**

#### Northeast

Wilmington, MA Tel: 978-658-1663

#### Southeast

Lake Mary, FL Tel: 407-855-8886

#### Central

Novi, MI

Tel: 248-994-1030

Irving, TX

Tel: 972-915-6041

#### West

Milpitas, CA Tel: 408-433-9950

#### Mexico

Guadalajara, Jalisco Tel: 52-33-3123-2141

#### **Europe**

#### Southern Europe Sasso Marconi, Italy Tel: 39-051-939111

Skopje, Macedonia Tel: 389-2-55-14-623

## **Central Europe**Landsberg, Germany

Tel: 49-8191-3350800

Kamen, Germany Tel: 49-2307-438110

#### Northern Europe

Wyboston, United Kingdom Tel: 44-1480-273082

Espoo, Finland Tel: 358-9-5406-5000

#### Asia

#### **Northeast Asia**

Hong Kong Tel: 852-2305-1168

Shenzhen, China Tel: 86-755-2518-1306

Beijing, China

Tel: 86-10-5877-1075

Shanghai, China Tel: 86-21-6447-0707

Seoul, South Korea Tel: 82-2-6294-0550

Taipei, Taiwan

Tel: 886-2-27528585

#### **Southeast Asia**

Singapore

Tel: 65-6701-8033

Penang, Malaysia Tel: 60-4-6430200

Bangalore, India Tel: 91-806-53-76817

Note: KEMET reserves the right to modify minor details of internal and external construction at any time in the interest of product improvement. KEMET does not assume any responsibility for infringement that might result from the use of KEMET Capacitors in potential circuit designs. KEMET is a registered trademark of KEMET Electronics Corporation.



#### **Disclaimer**

All product specifications, statements, information and data (collectively, the "Information") in this datasheet are subject to change. The customer is responsible for checking and verifying the extent to which the Information contained in this publication is applicable to an order at the time the order is placed.

All Information given herein is believed to be accurate and reliable, but it is presented without guarantee, warranty, or responsibility of any kind, expressed or implied.

Statements of suitability for certain applications are based on KEMET Electronics Corporation's ("KEMET") knowledge of typical operating conditions for such applications, but are not intended to constitute – and KEMET specifically disclaims – any warranty concerning suitability for a specific customer application or use. The Information is intended for use only by customers who have the requisite experience and capability to determine the correct products for their application. Any technical advice inferred from this Information or otherwise provided by KEMET with reference to the use of KEMET's products is given gratis, and KEMET assumes no obligation or liability for the advice given or results obtained.

Although KEMET designs and manufactures its products to the most stringent quality and safety standards, given the current state of the art, isolated component failures may still occur. Accordingly, customer applications which require a high degree of reliability or safety should employ suitable designs or other safeguards (such as installation of protective circuitry or redundancies) in order to ensure that the failure of an electrical component does not result in a risk of personal injury or property damage.

Although all product-related warnings, cautions and notes must be observed, the customer should not assume that all safety measures are indicted or that other measures may not be required.

## **X-ON Electronics**

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Film Capacitors category:

Click to view products by Kemet manufacturer:

Other Similar products are found below:

F339X134748MIP2T0 F450KG153J250ALH0J 750-1018 FKP1-1500160010P15 FKP1R031007D00JYSD FKP1R031507E00JYSD FKP1U024707E00KYSD 82DC4100CK60J 82EC1100DQ50K PFR5101J100J11L16.5TA18 PME261JB5220KR19T0 A451GK223M040A A561ED221M450A QXJ2E474KTPT QXL2B333KTPT R49AN347000A1K EEC2G505HQA406 B25668A6676A375 B25673A4282E140 BFC233868148 BFC2370GC222 C3B2AD44400B20K C4ASWBU3220A3EK CB027C0473J-- CB177I0184J-- CB182K0184J-- 23PW210 950CQW5H-F SBDC3470AA10J SCD105K122A3-22 2N3155 A571EH331M450A FKP1-2202KV5P15 FKS3-680040010P10 QXL2E473KTPT 445450-1 B25669A3996J375 46KI322000M1M 46KR415050M1K 4BSNBX4100ZBFJ MKP383510063JKP2T0 MKPY2-.02230020P15 MKT 1813-368-015 4055292001 46KN410000N1K EEC2E106HQA405 EEC2G205HQA402 EEC2G805HQA415 P409CP224M250AH470 82EC2150DQ50K